

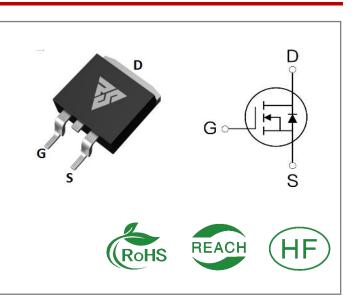
ID	R <sub>Ds</sub> (ON)(Typ)	VDSS
120A	4.3mΩ	100V

# Applications:

- Load Switch
- PWM Applications
- Power Managment

#### Features:

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability



## **Ordering Information**

Part Number	Package	Marking	Packing	Qty.
RS100N120S	T0-263	RS100N120S	Tape&reel	800 PCS

## Absolute Maximun Ratings Tc= 25°C unless otherwise specified

Symbol	Parameter	RS100N120S	Units
VDSS	Drain-to-Source Voltage	100	V
ID	Continuous Drain Current TC=25℃	120	
ID	Continuous Drain Current TC=100°C	80	А
IDM	Pulsed Drain Current	480	
PD	Power Dissipation	178	W
VGS	Gate- to- Source Voltage	±20	V
EAS	Single Pulse Avalanche Engergy L = 3.0mH,VDS = 50V, RG = 25Ω, Tj = 25℃	486	mJ
	Maximum Temperature for Soldering		
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds	300 260	°C
TJ and TSTG	Operating Junction and Storage Temperature Range	-55 to 150	

\* Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the" Absolute Maximum Ratings" Table may cause permanent damage to the device.



# **Thermal Resistance**

Symbol	Parameter	RS100N120S	Units	Test Conditions
RθJC	Junction-to-Case	0.7	°C/W	Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of + 1 5 0 $^{\circ}$ C
RθJA	Junction-to- Ambient	46		1 cubic foot chamber,free air.

# **OFF Characteristics** TJ= $25^{\circ}$ C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	100			V	VGS=0V,ID=250μ Α
IDSS	Drain- to- Source Leakage Current			1	μA	VDS=80V,VGS=0 V
	Gate- to- Source Forward Leakage			100	- 4	VGS=20V ,VDS=0 V
IGSS	Gate- to- Source Reverse Leakage			-100	nA	VGS=-20V ,VDS= 0V

# **ON Characteristics** TJ=25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
	Static Drain- to- Source On-		4.3	5.3	mΩ	VGS=10V,ID=20A
RDS(on) Resistance		5.5	7.5	mΩ	VGS=4.5V,ID=10 A	
VGS(TH )	Gate Threshold Voltage	2	3	4	V	VGS=VDS,ID=25 0μA

# **Resistive Switching Characteristics** Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		18			
trise	Rise Time		23			VDS=50V ID=20A
td(OFF)	Turn- OFF Delay Time		37		nS	RG=3Ω VGS=10V
tfall	Fall Time		16			VG3-10V



### **Dynamic Characteristics** Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance		4100			VGS= 0V
Coss	Output Capacitance		590		pF	VDS=50V
Crss	Reverse Transfer Capacitance		20			f=1MHz
Qg	Total Gate Charge		69			VDS= 50V
Qgs	Gate- to- Source Charge		24		nC	ID=20A
Qgd	Gate-to-Drain(" Miller") Charge	19 VGS=	VGS=10V			

## **Source- Drain Diode Characteristics**

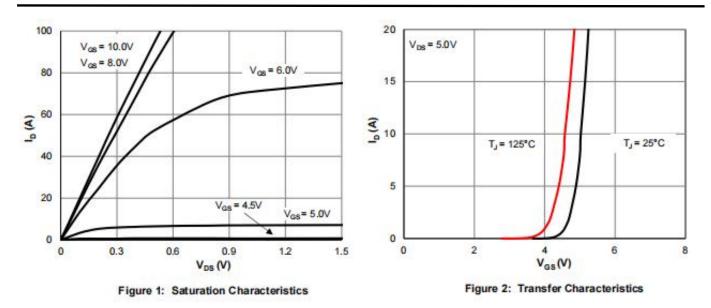
Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
IS	Continuous Source Current			120	А	Integral pn- diode
ISM	Maximum Pulsed Current			480	А	in MOSFET
VSD	Diode Forward Voltage			1.0	V	IS=20A,VGS=0V
trr	Reverse Recovery Time		64		nS	VGS=0V
Qrr	Reverse Recovery Charge		126		nC	IS=20A di/dt=100A/μs

Notes:

\* 1. Repetitive rating, pulse width limited by maximum junction temperature.

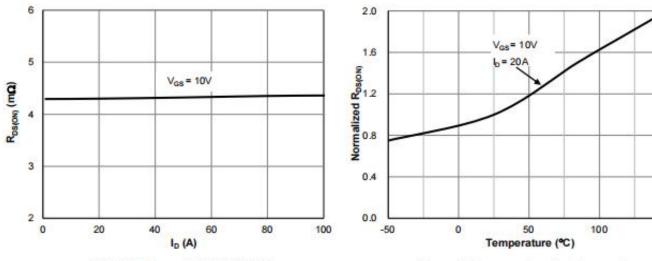
\* 2. Pulse Test: Pulse width  $\leq$  300µs, Duty Cycle  $\leq$  1%

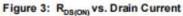
## **Typical Feature Curve**



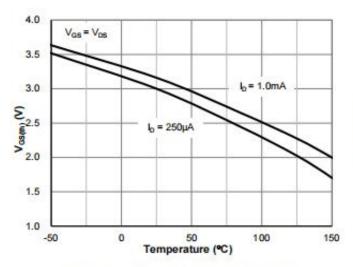


150

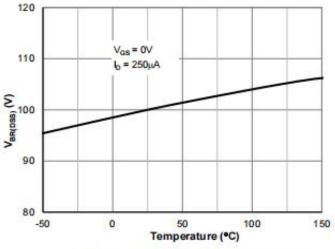




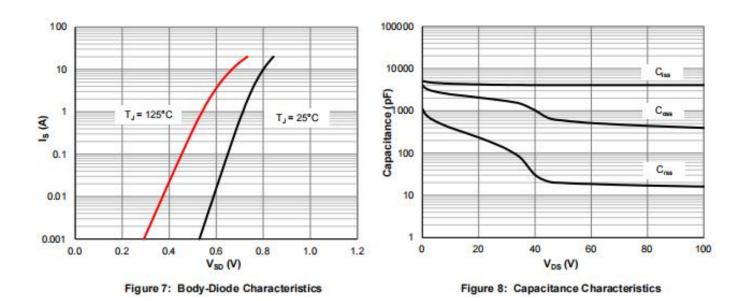












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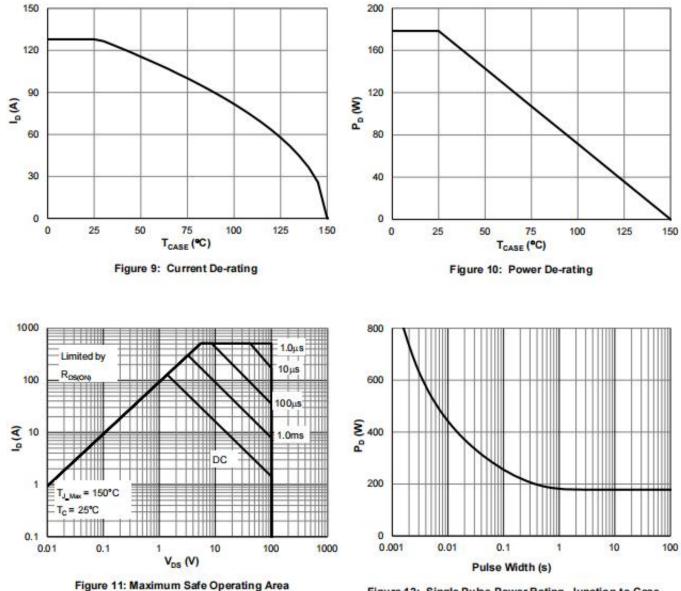


Figure 12: Single Pulse Power Rating, Junction-to-Case

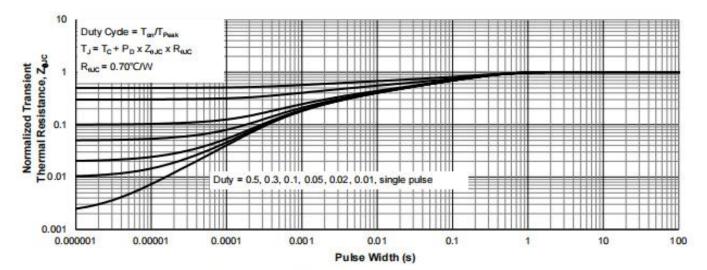
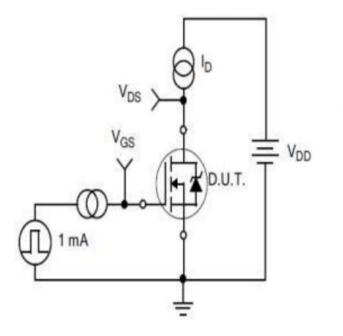


Figure 13: Normalized Maximum Transient Thermal Impedance



# Test ircuits and Waveforms



VGS(TH)

VDS

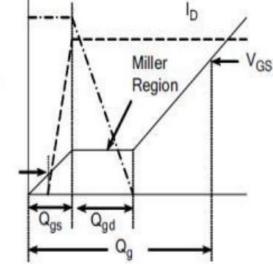


Figure A. Gate Charge Test Circuit

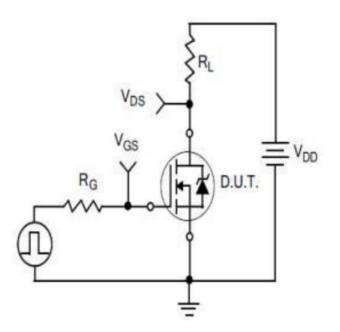


Figure C. Resistive Switching Test Circuit

Figure B. Gate Charge Waveform

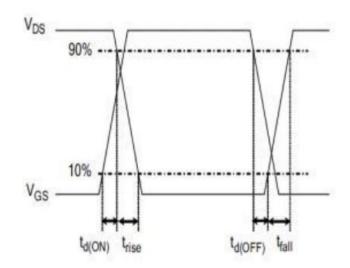
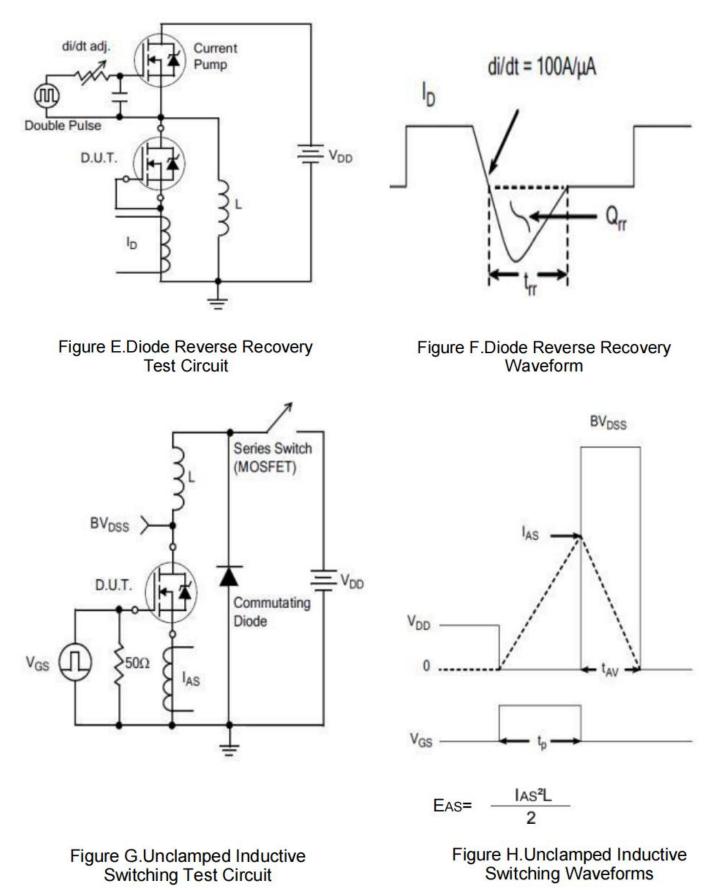


Figure D. Resistive Switching Waveforms

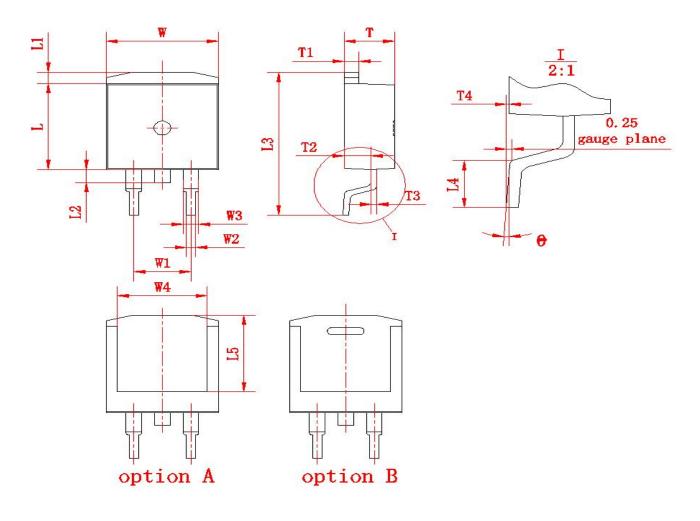


# Test ircuits and Waveforms





# Package outline drawing(TO-263 Unit: mm)



(单位: mm)

符号	尺寸		竹口	尺寸		竹口	尺寸	
নিস	Min	Max	符号	Min	Max	符号	Min	Max
W	9.80	10.20	L1	1.00	1.40	T1	1.20	1.40
<b>W1</b>	(5.	08)	L2	1.20	1.60	T2	2.20	2.60
<b>W</b> 2	0.70	0.95	L3	15.00	15.60	Т3	0.45	0.65
W3	1.17	1.62	L4	2.20	2.80	T4	0	0. 25
<b>W</b> 4	(8)	. 0)	L5	(8.2)		θ	0°	<mark>8°</mark>
L	9.00	9.40	Т	4.30	4.70			



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